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HUA HONG GRACE SEMICONDUCTOR LIMITED

華虹宏力半導體有限公司

(formerly known as Hua Hong Semiconductor Limited 華虹半導體有限公司)

(Incorporated in Hong Kong with limited liability)

(Stock Code: 1347)

CHANGE OF COMPANY NAME AND STOCK SHORT NAME

Reference is made to the circular of Hua Hong Grace Semiconductor Limited 華虹宏力半導體有限公司 (formerly known as Hua Hong Semiconductor Limited 華虹半導體有限公司) (the “**Company**”) dated 9 April 2026 (the “**Circular**”) in connection with the Proposed Change of Company Name and the AGM poll results announcement of the Company dated 14 May 2026. Capitalised terms used in this announcement have the same meanings as those defined in the Circular unless otherwise stated.

CHANGE OF COMPANY NAME

The Board is pleased to announce that following the passing of the special resolution for the Proposed Change of Company Name at the AGM held on 14 May 2026, the Certificate of Change of Name bearing the new English and Chinese names of the Company has been issued by the Companies Registry in Hong Kong on 27 May 2026. The conditions for the Change of Name have therefore been satisfied and the change of the English name of the Company from “Hua Hong Semiconductor Limited” to “Hua Hong Grace Semiconductor Limited” and the Chinese name of the Company from “華虹半導體有限公司” to “華虹宏力半導體有限公司”, effective on 27 May 2026.

CHANGE OF STOCK SHORT NAME

With effect from 9 a.m. on 8 June 2026, the English stock short name of the Company will be changed from “HUA HONG SEMI” to “HUA HONG GRACE” and the Chinese stock short name of the Company will be changed from “華虹半導體” to “華虹宏力” for trading in the Shares on the Main Board of the Stock Exchange. The stock code of the Company on the Stock Exchange will remain unchanged as “1347”.

EFFECTS ON SHAREHOLDERS

The above changes will not affect the rights of Shareholders or the Group's operations and financial position. All existing share certificates in issue bearing the former name of the Company shall continue to be good evidence of legal title to such Shares and the share certificates will continue to be valid for trading, settlement, registration and delivery purposes. There will not be any arrangement for free exchange of the share certificates of the Company under its former name for new share certificates under the new name of the Company. New share certificates of the Company will be issued under the new names of the Company with effect from 8 June 2026.

By order of the Board
Hua Hong Grace Semiconductor Limited
Dr. Peng Bai
Chairman and Executive Director

Hong Kong, 3 June 2026

As at the date of this announcement, the directors of the Company are:

Executive Director:

Peng Bai (*Chairman and President*)

Non-executive Directors:

Jun Ye

Guodong Sun

Bo Chen

Chengyan Xiong

Independent Non-executive Directors:

Stephen Tso Tung Chang

Kwai Huen Wong, JP

Songlin Feng